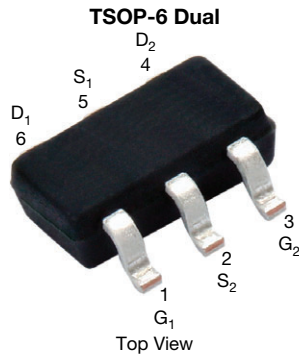


N- and P-Channel 30 V (D-S) MOSFET



FEATURES

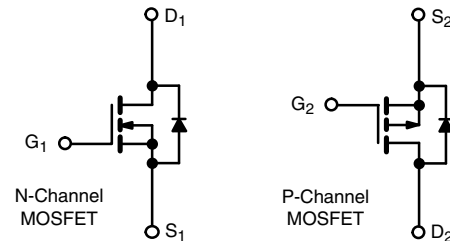
- TrenchFET® power MOSFET
- Ultra low $R_{DS(on)}$ n- and p-channel for high efficiency
- Optimized for high side / low side
- Minimized conduction losses
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Portable devices including PDAs, cellular phones, and pagers

PRODUCT SUMMARY		
	N-CHANNEL	P-CHANNEL
V_{DS} (V)	30	-30
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 4.5$ V	0.077	0.170
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 2.5$ V	0.120	0.300
Q_g typ. (nC)	3	3.8
I_D (A)	3	-2
Configuration	N- and p-pair	



ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3590DV-T1-E3
Lead (Pb)-free and halogen-free	Si3590DV-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)							
PARAMETER	SYMBOL	N-CHANNEL		P-CHANNEL		UNIT	
		10 s	STEADY STATE	10 s	STEADY STATE		
Drain-source voltage	V_{DS}	30		-30		V	
Gate-source voltage	V_{GS}	± 12		± 12			
Continuous drain current ($T_J = 150$ °C) ^a	I_D	$T_A = 25$ °C	3	2.5	-2	-1.7	A
		$T_A = 70$ °C	2.3	2	-1.6	-1.3	
Pulsed drain current	I_{DM}	8		-8		A	
Continuous source current (diode conduction) ^a	I_S	1.05	0.75	-1.05	-0.75		
maximum power dissipation ^a	P_D	$T_A = 25$ °C	1.15	0.83	1.15	0.83	W
		$T_A = 70$ °C	0.70	0.53	0.70	0.53	
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +150				°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	N-CHANNEL		P-CHANNEL		UNIT	
		TYP.	MAX.	TYP.	MAX.		
Maximum junction-to-ambient ^a	R_{thJA}	$t \leq 10$ s	93	110	93	110	°C/W
		Steady state	130	150	130	150	
Maximum junction-to-foot (drain)	R_{thJF}	75	90	75	90		

Note

a. Surface mounted on 1" x 1" FR4 board



SPECIFICATIONS (T _J = 25°C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.6	-	1.5	V	
		V _{DS} = V _{GS} , I _D = -250 μA	P-Ch	-0.6	-	-1.5		
Gate-body leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 12 V	N-Ch	-	-	± 100	nA	
			P-Ch	-	-	± 100		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	N-Ch	-	-	1	μA	
			P-Ch	-	-	-1		
			V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch	-	-		5
			V _{DS} = -30 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch	-	-		-5
On-state drain current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 4.5 V	N-Ch	5	-	-	A	
		V _{DS} ≤ -5 V, V _{GS} = -4.5 V	P-Ch	-5	-	-		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 3 A	N-Ch	-	0.062	0.077	Ω	
			V _{GS} = -4.5 V, I _D = -2 A	P-Ch	-	0.135		0.170
			V _{GS} = 2.5 V, I _D = 2 A	N-Ch	-	0.095		0.120
			V _{GS} = -2.5 V, I _D = -1.2 A	P-Ch	-	0.235		0.300
Forward transconductance ^a	g _{fs}	V _{DS} = 5 V, I _D = 3 A	N-Ch	-	10	-	S	
		V _{DS} = -5 V, I _D = -2 A	P-Ch	-	5	-		
Diode forward voltage ^a	V _{SD}	I _S = 1.05 A, V _{GS} = 0 V	N-Ch	-	0.8	1.1	V	
		I _S = -1.05 A, V _{GS} = 0 V	P-Ch	-	-0.83	-1.1		
Dynamic ^b								
Total gate charge	Q _g	N-Channel V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 2 A P-Channel V _{DS} = -15 V, V _{GS} = -4.5 V, I _D = -2 A	N-Ch	-	3	4.5	nC	
			P-Ch	-	3.8	6		
Gate-source charge	Q _{gs}		N-Ch	-	0.6	-		
			P-Ch	-	0.6	-		
Gate-drain charge	Q _{gd}		N-Ch	-	1	-		
			P-Ch	-	1.5	-		
Turn-on delay time	t _{d(on)}	N-Channel V _{DD} = 15 V, R _L = 15 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _g = 6 Ω P-Channel V _{DD} = -15 V, R _L = 15 Ω I _D ≅ -1 A, V _{GEN} = -10 V, R _g = 6 Ω	N-Ch	-	5	8	ns	
			P-Ch	-	5	8		
Rise time	t _r		N-Ch	-	12	23		
			P-Ch	-	15	23		
Turn-off delay time	t _{d(off)}		N-Ch	-	13	23		
			P-Ch	-	20	30		
Fall time	t _f		N-Ch	-	7	12		
			P-Ch	-	20	30		
Source-drain reverse recovery time	t _{rr}		I _F = 1.05 A, di/dt = 100 A/μs	N-Ch	-	15		25
			I _F = -1.05 A, di/dt = 100 A/μs	P-Ch	-	18		30

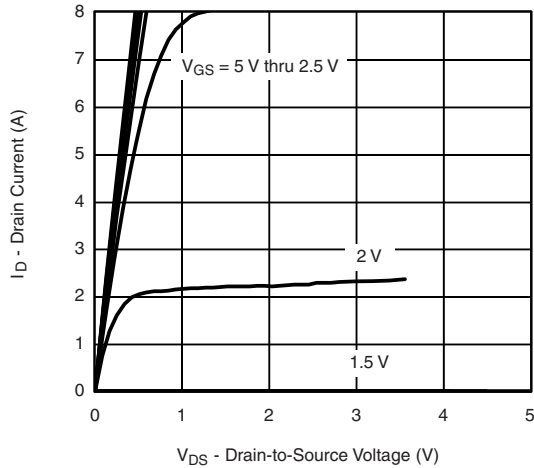
Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing

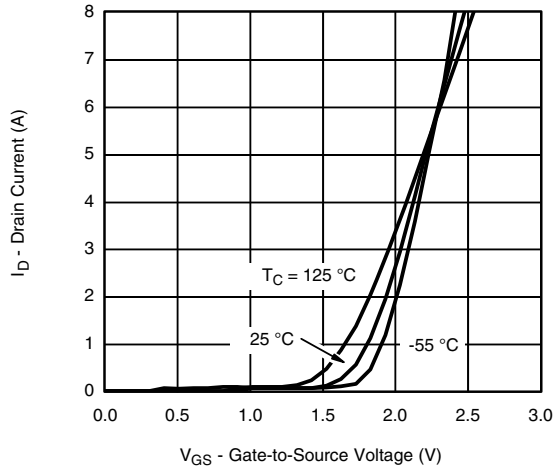
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.



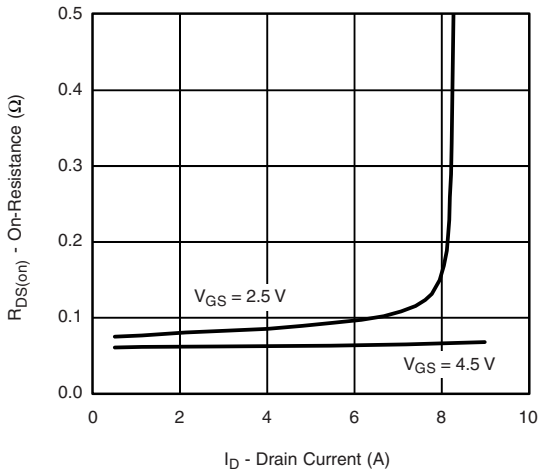
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



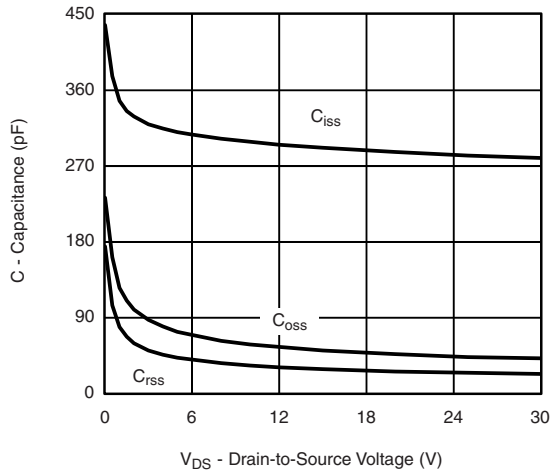
Output Characteristics



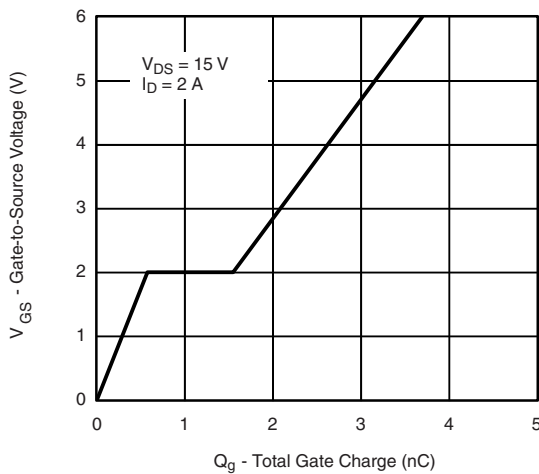
Transfer Characteristics



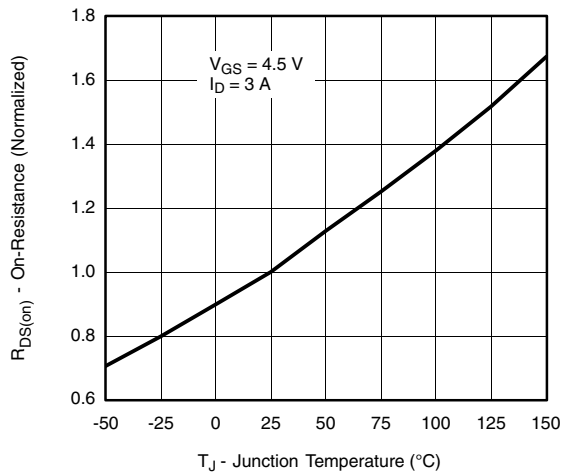
On-Resistance vs. Drain Current



Capacitance

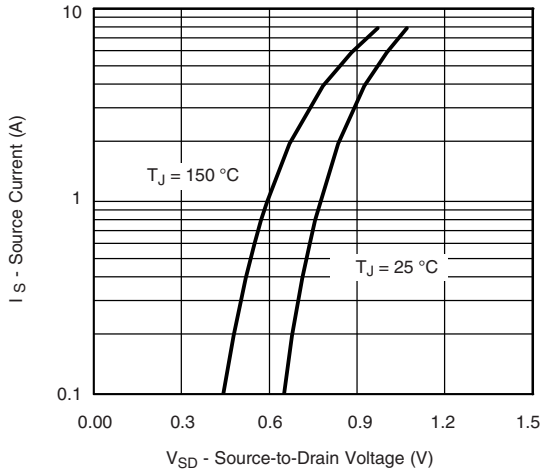


Gate Charge

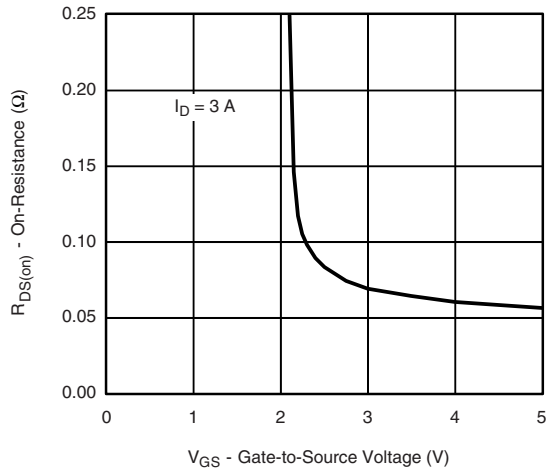


On-Resistance vs. Junction Temperature

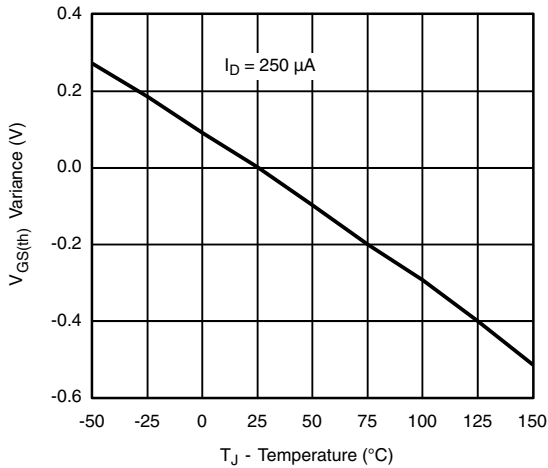
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



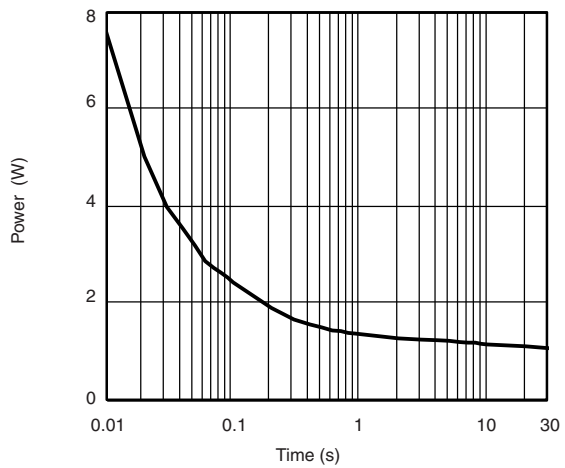
Source-Drain Diode Forward Voltage



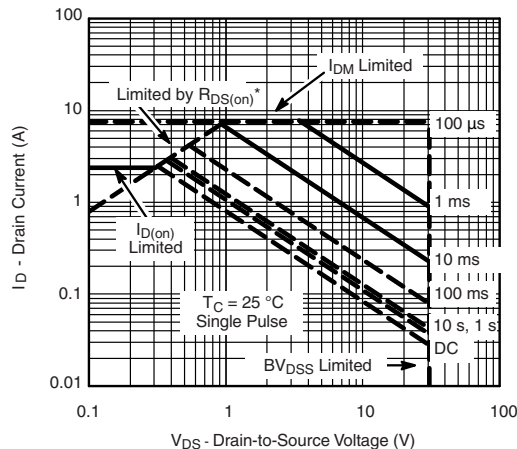
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

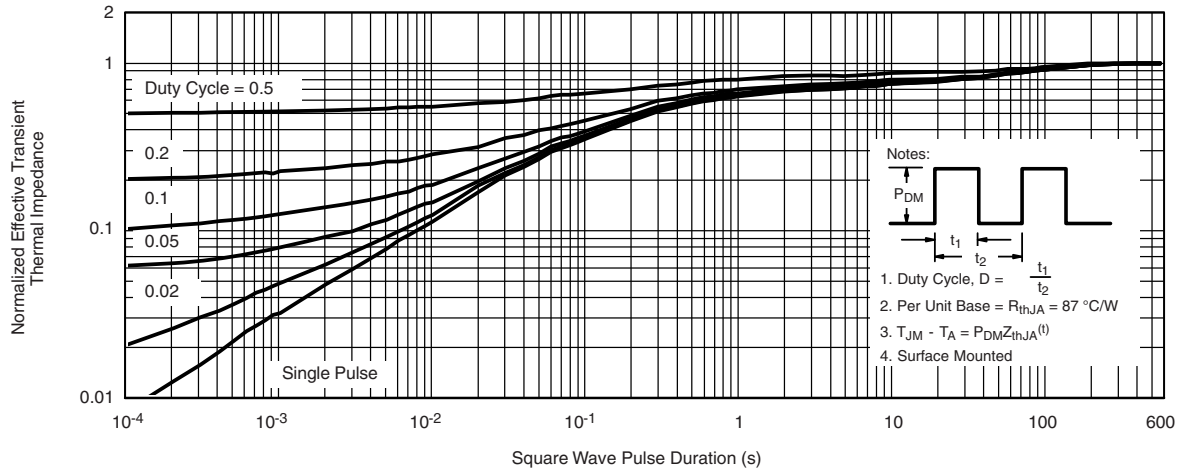


* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

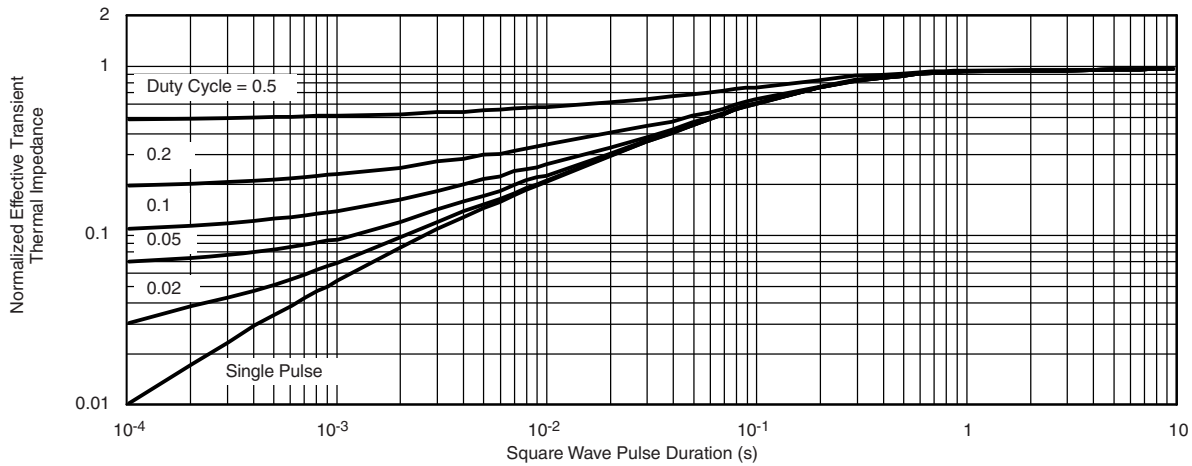
Safe Operating Area, Junction-to-Case



N-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



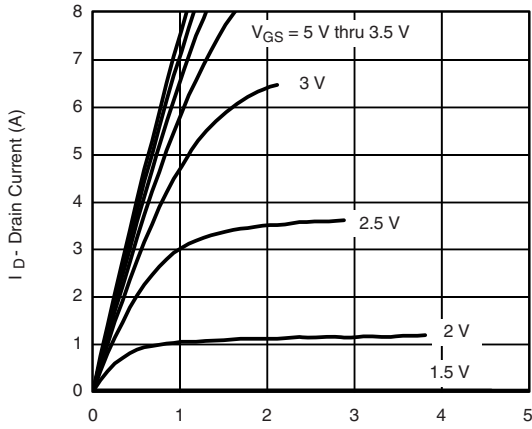
Normalized Thermal Transient Impedance, Junction-to-Ambient



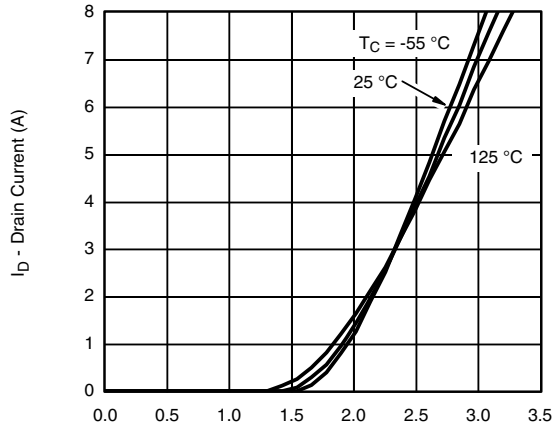
Normalized Thermal Transient Impedance, Junction-to-Foot



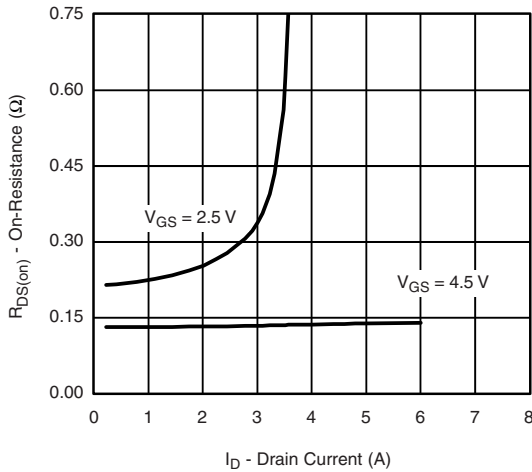
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



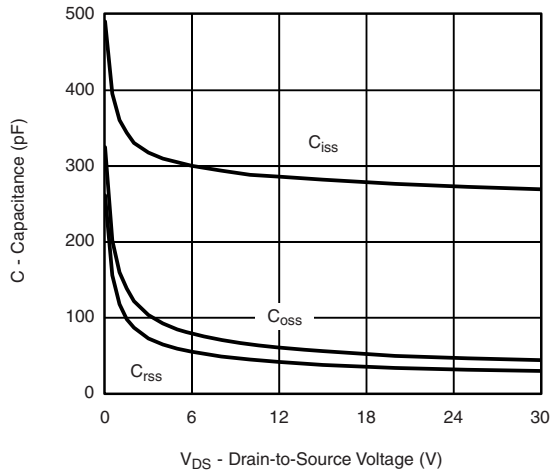
Output Characteristics



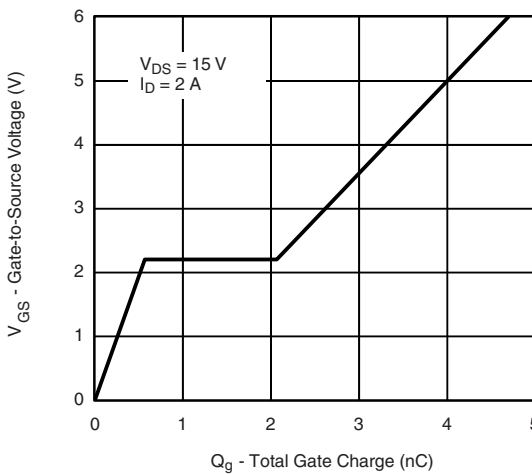
Transfer Characteristics



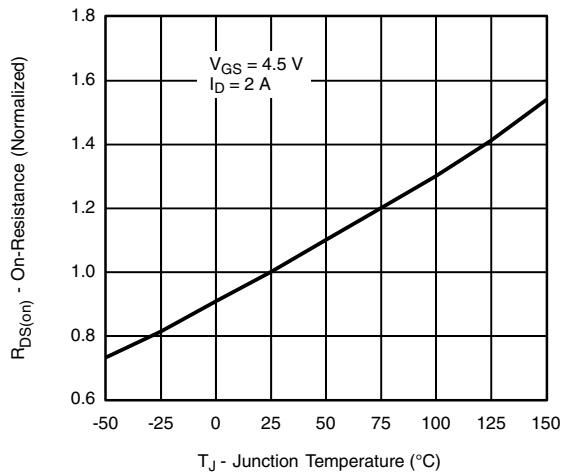
On-Resistance vs. Drain Current



Capacitance



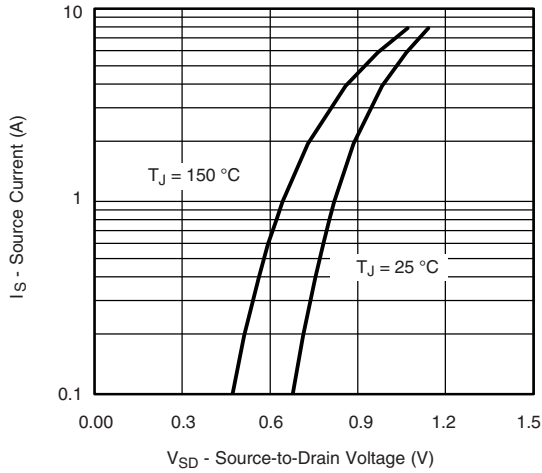
Gate Charge



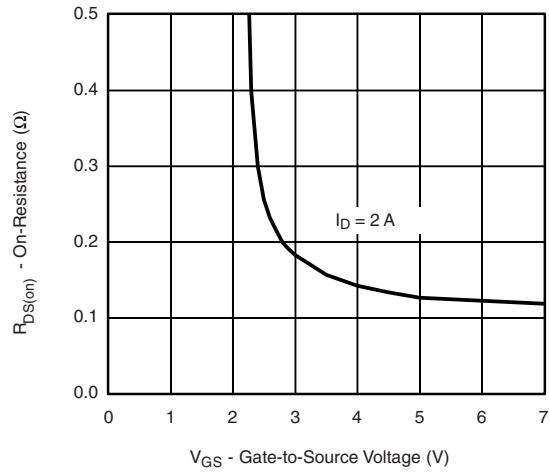
On-Resistance vs. Junction Temperature



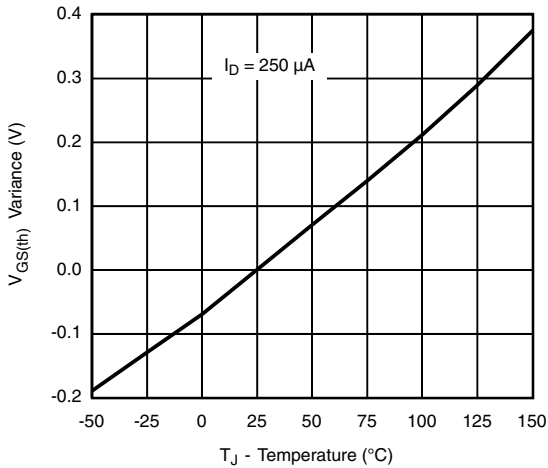
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



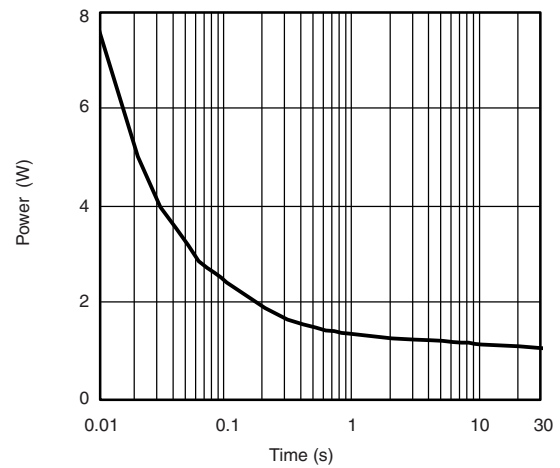
Source-Drain Diode Forward Voltage



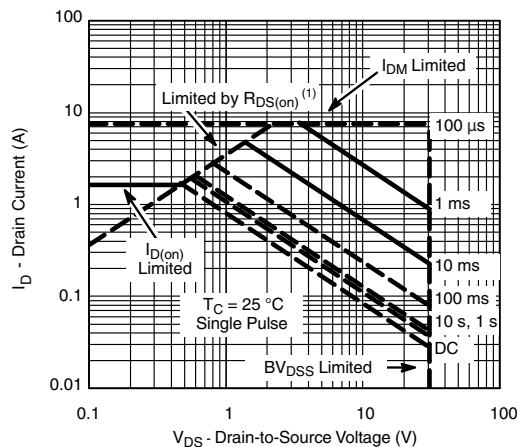
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

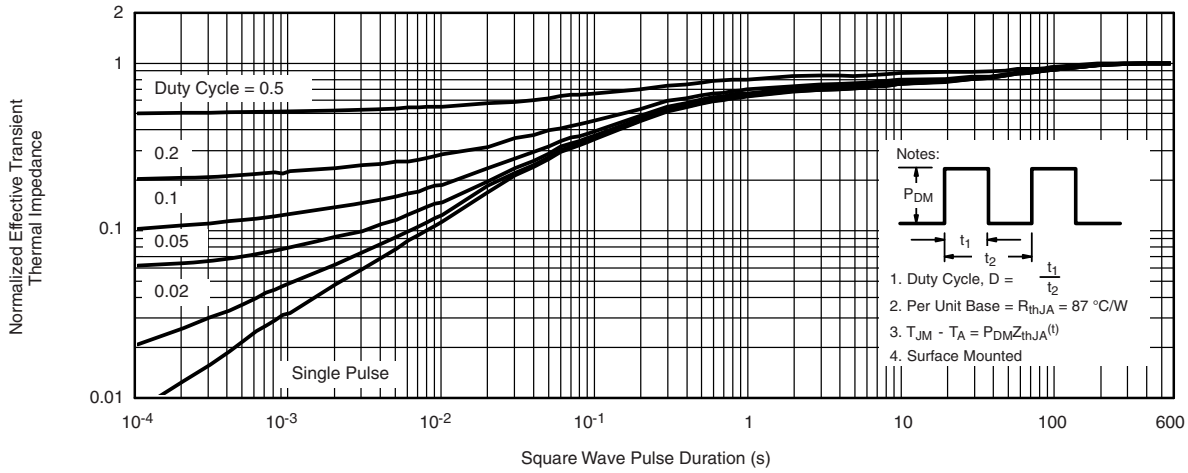


(1) $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

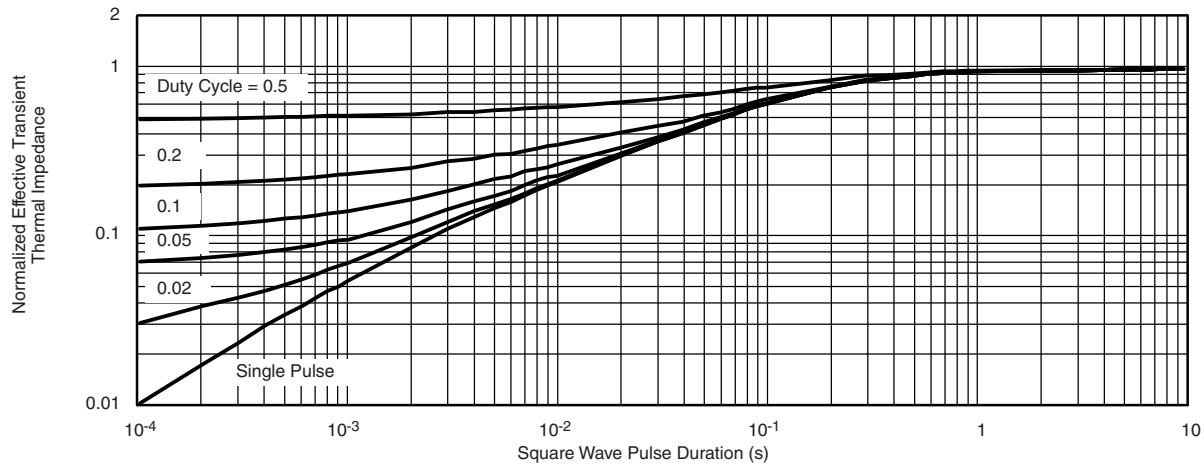
Safe Operating Area, Junction-to-Case



P-CHANNEL TYPICAL CHARACTERISTICS (25 °C unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

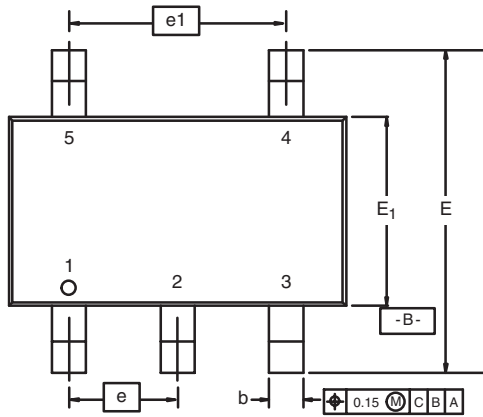


Normalized Thermal Transient Impedance, Junction-to-Foot

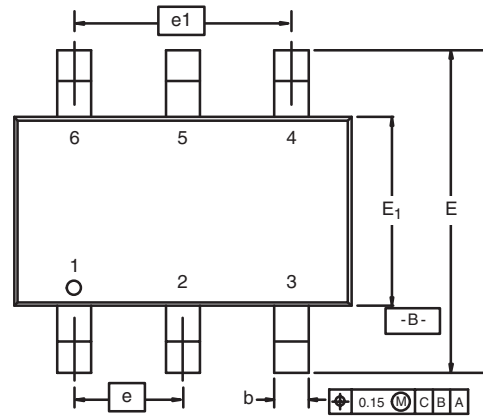
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TSOP: 5/6-LEAD

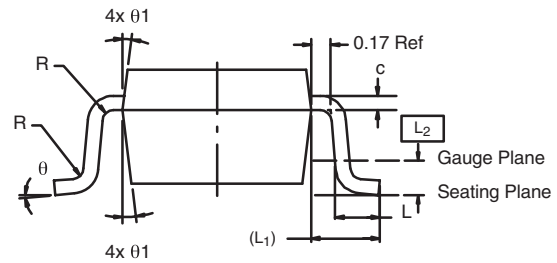
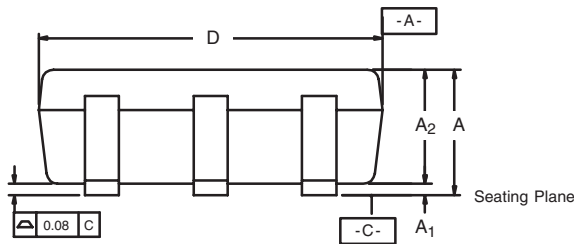
JEDEC Part Number: MO-193C



5-LEAD TSOP



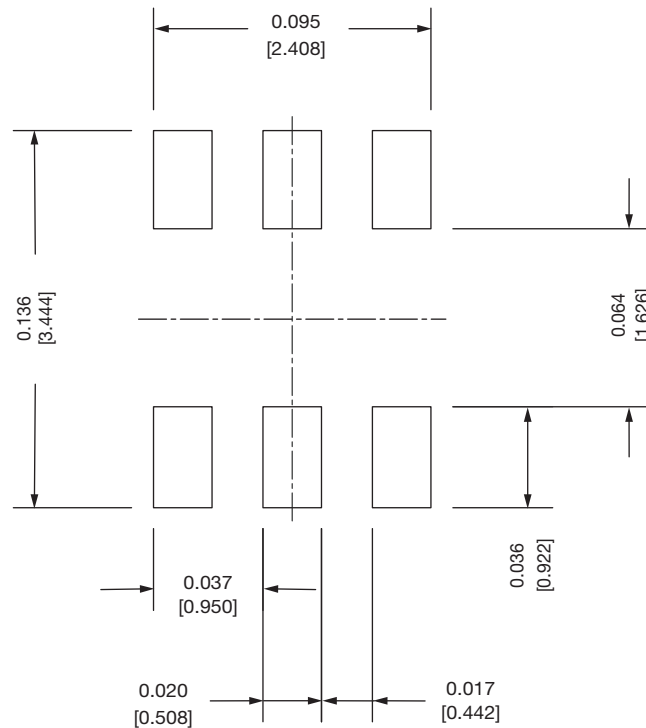
6-LEAD TSOP



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.91	-	1.10	0.036	-	0.043
A₁	0.01	-	0.10	0.0004	-	0.004
A₂	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E₁	1.55	1.65	1.70	0.061	0.065	0.067
e	0.95 BSC			0.0374 BSC		
e₁	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L₁	0.60 Ref			0.024 Ref		
L₂	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ₁	7° Nom			7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06						
DWG: 5540						



Recommended Land Pattern For TSOP-5L / TSOP-6L



Note

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022
DWG: 3010



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